



US00D967805S

(12) **United States Design Patent**  
**Hong**

(10) **Patent No.:** **US D967,805 S**

(45) **Date of Patent:** **\*\* Oct. 25, 2022**

(54) **BLUETOOTH EARPHONE**

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(\*\*) Term: **15 Years**

(21) Appl. No.: **29/803,682**

(22) Filed: **Aug. 16, 2021**

(30) **Foreign Application Priority Data**

Aug. 9, 2021 (CN) ..... 202130513379.7

(51) **LOC (13) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/223**

(58) **Field of Classification Search**  
USPC ..... D14/204–206, 223  
CPC .. H04R 1/1083; H04R 1/1041; H04R 1/1016;  
H04R 5/0335  
See application file for complete search history.

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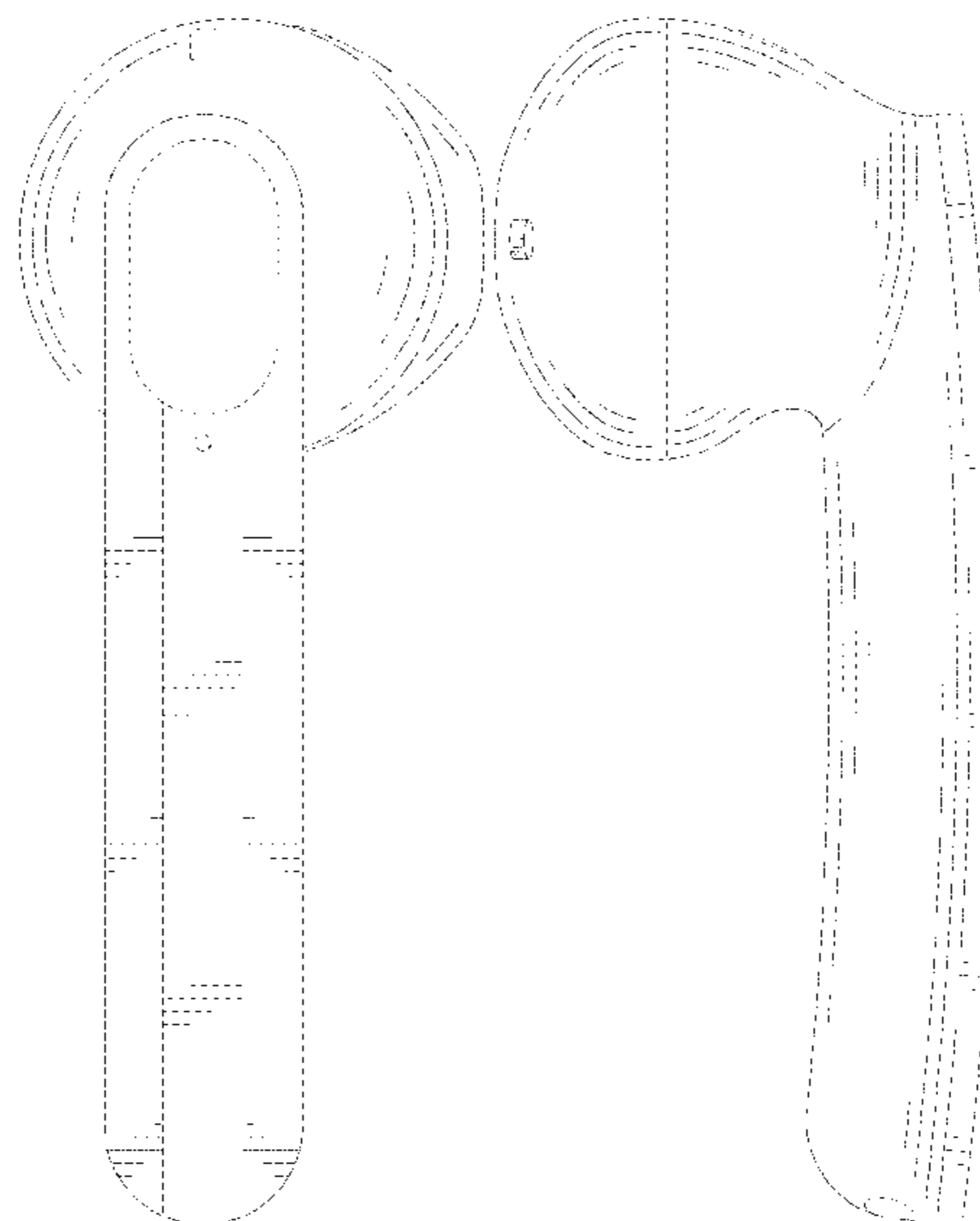
(57) **CLAIM**

The ornamental design for a Bluetooth earphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a front elevation view for a Bluetooth earphone showing my new design;  
FIG. 2 is a rear elevation view thereof;  
FIG. 3 is a left side elevation view thereof;  
FIG. 4 is a right side elevation view thereof;  
FIG. 5 is a top plan view thereof;  
FIG. 6 is a bottom plan view thereof;  
FIG. 7 is an enlarged view from the indication in FIG. 2 thereof; and,  
FIG. 8 is a front,top perspective view thereof.  
The broken lines in the drawings depict environment and features of the Bluetooth earphone that form no part of the claimed design.

**1 Claim, 8 Drawing Sheets**



(56)

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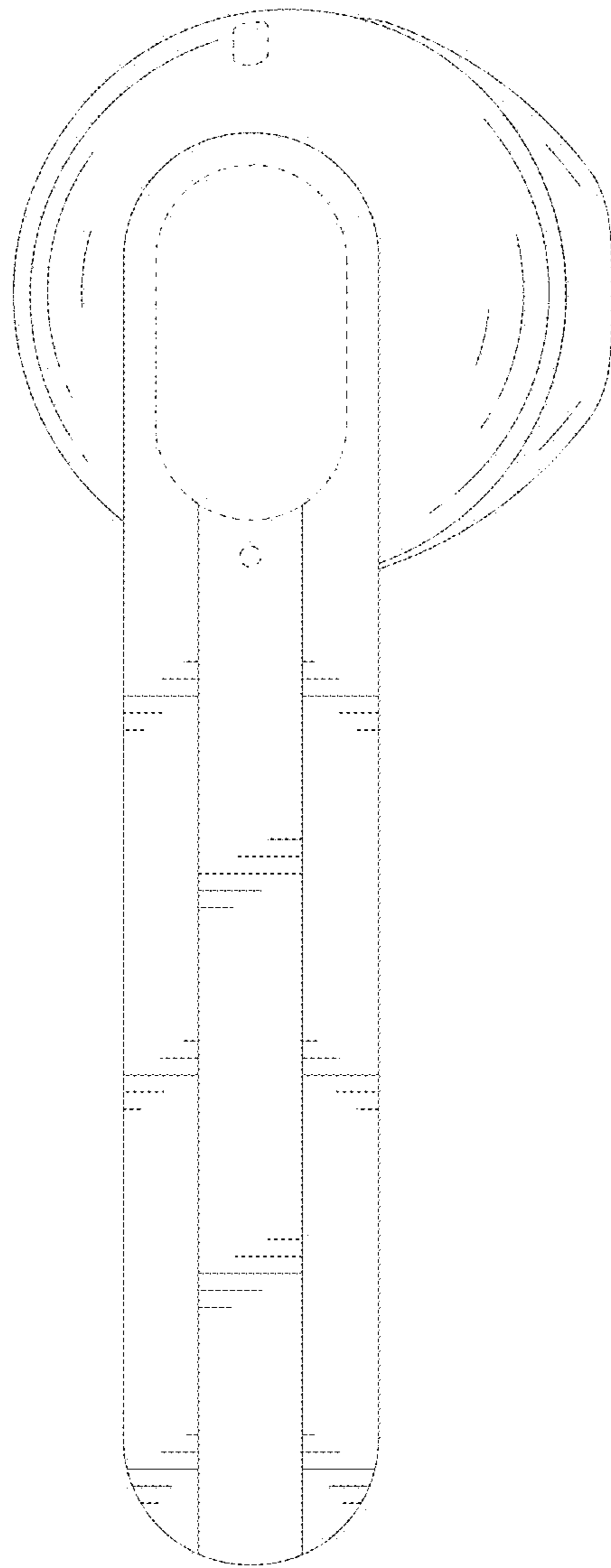


FIG. 1

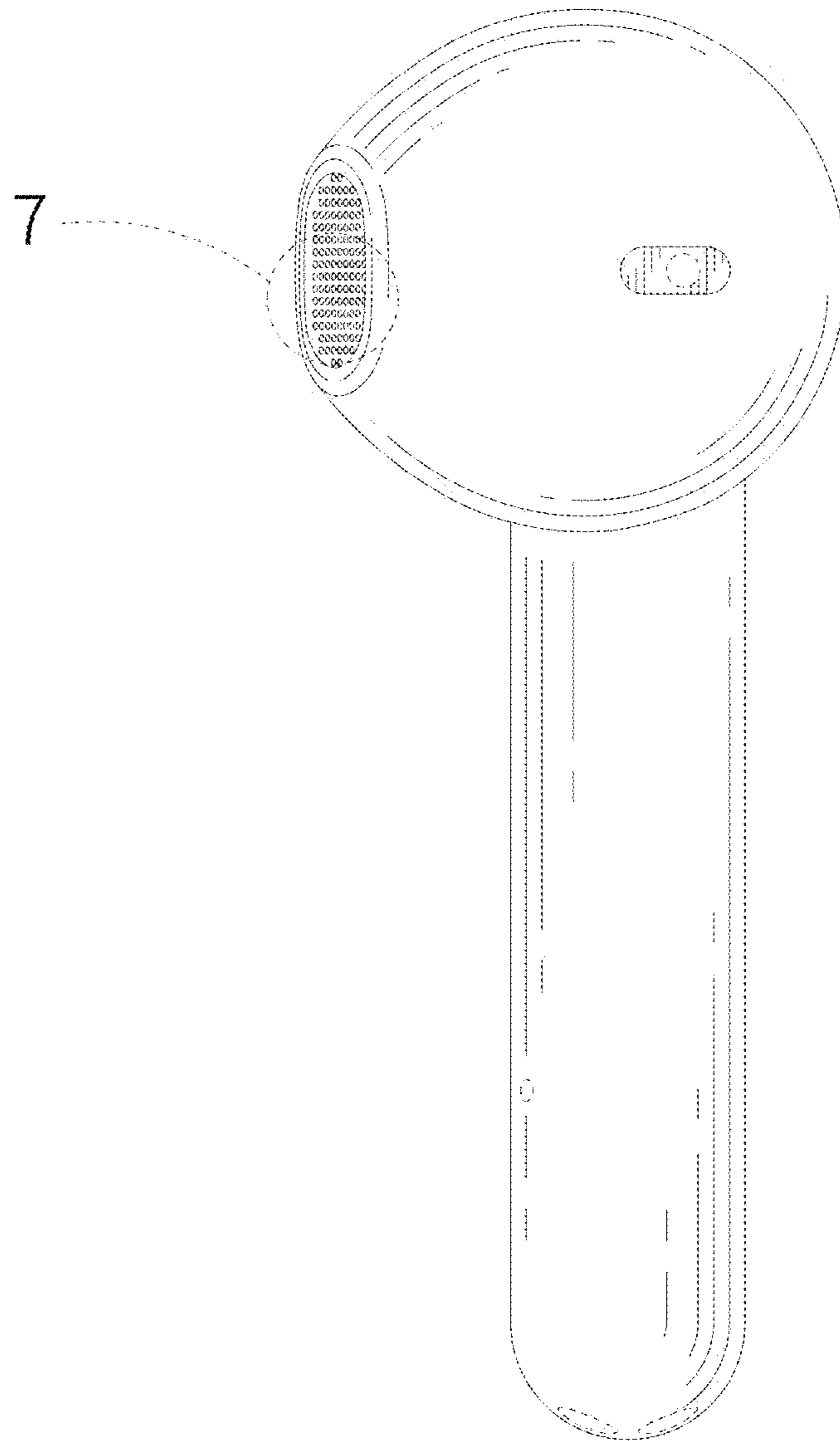


FIG. 2

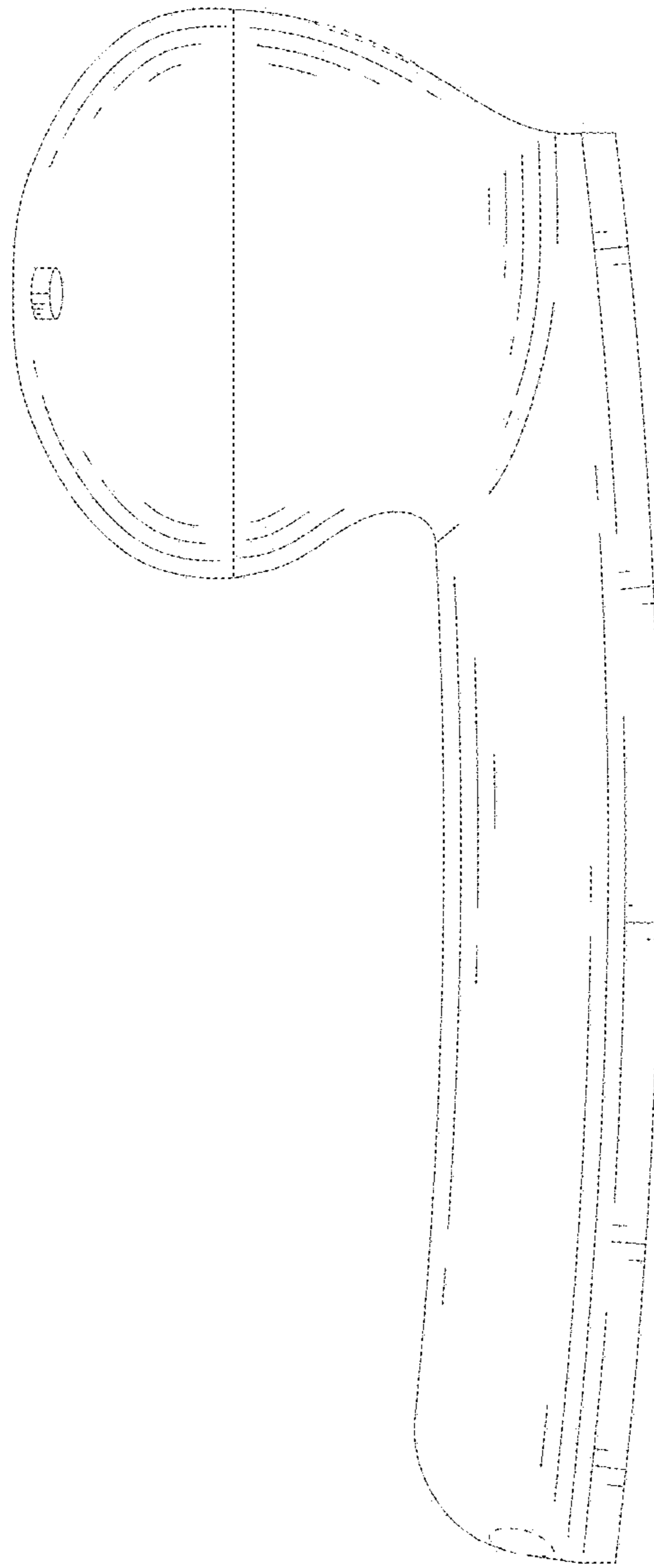


FIG. 3

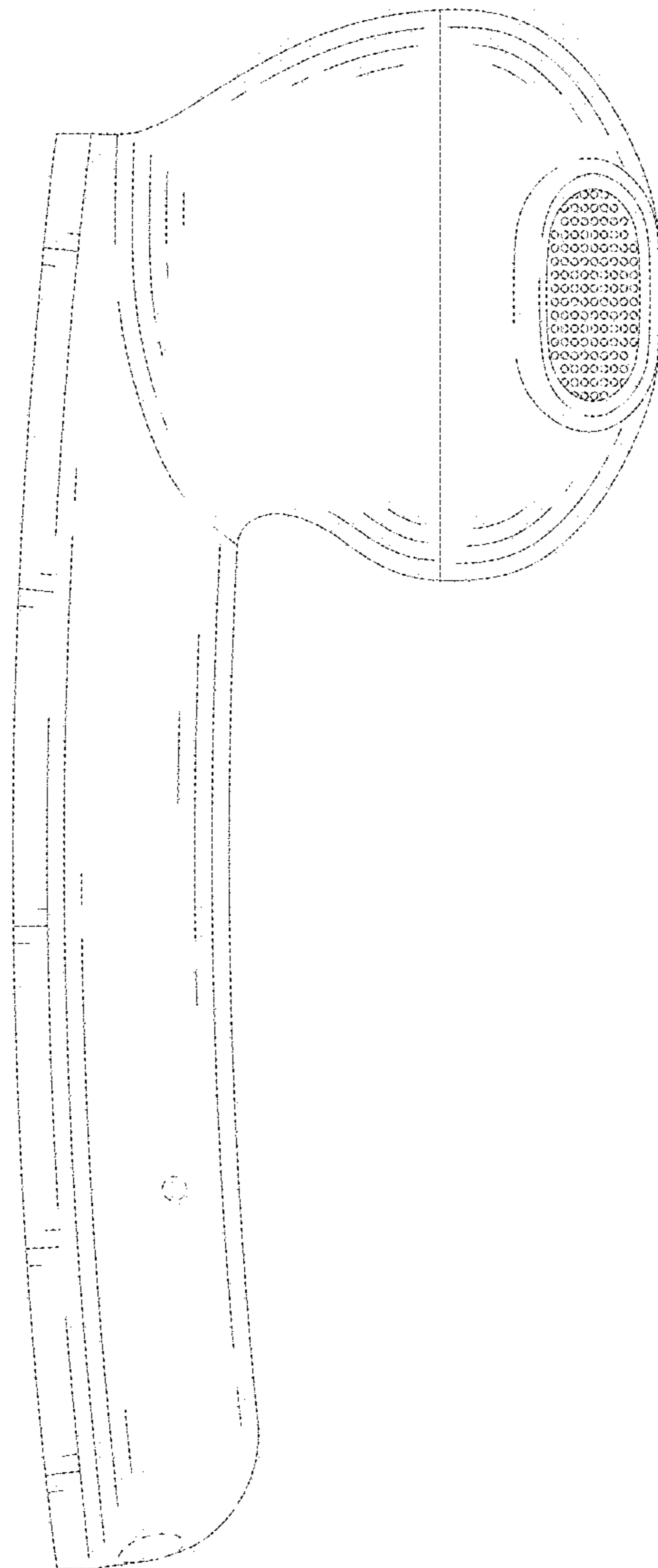


FIG. 4

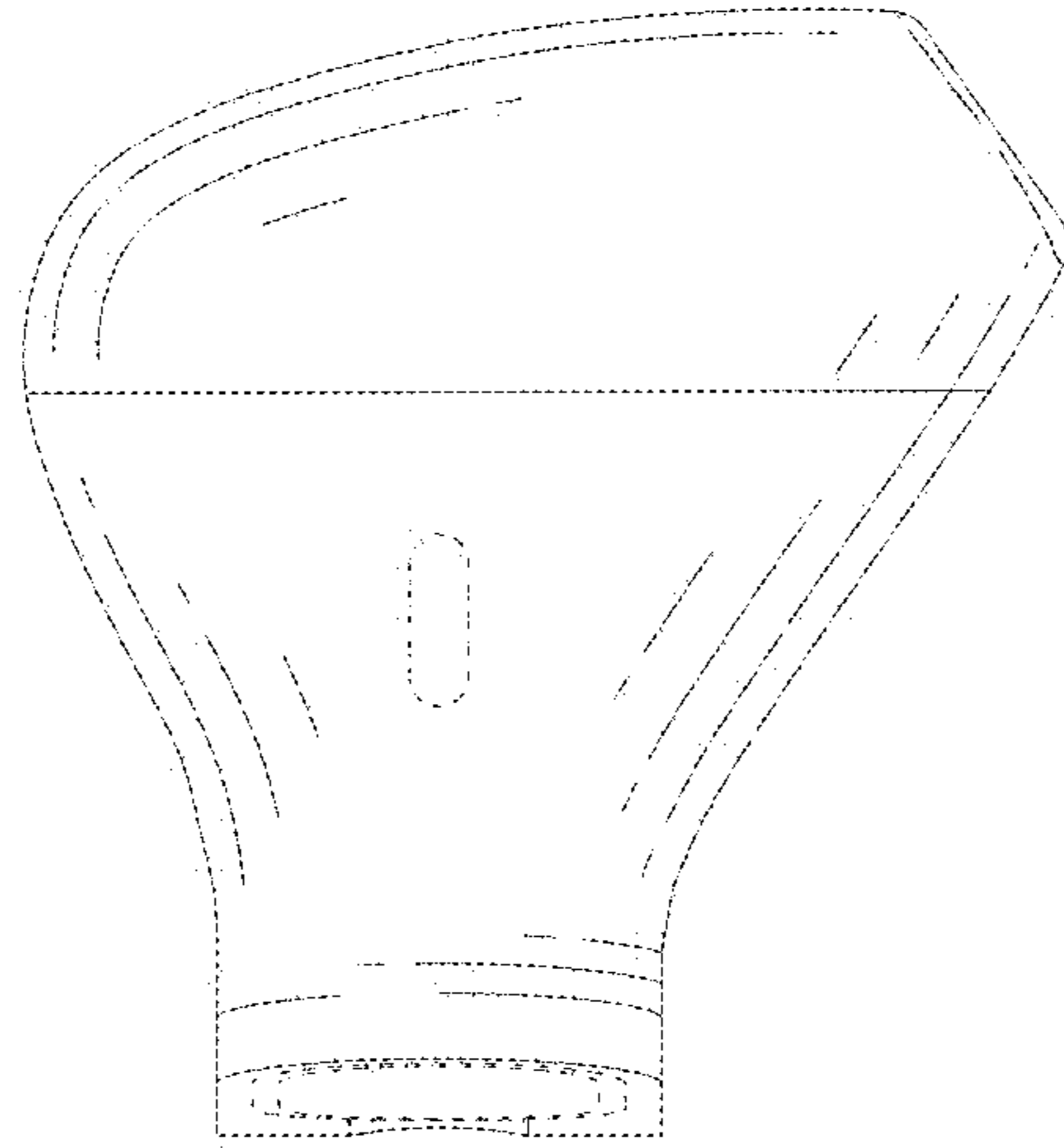


FIG. 5

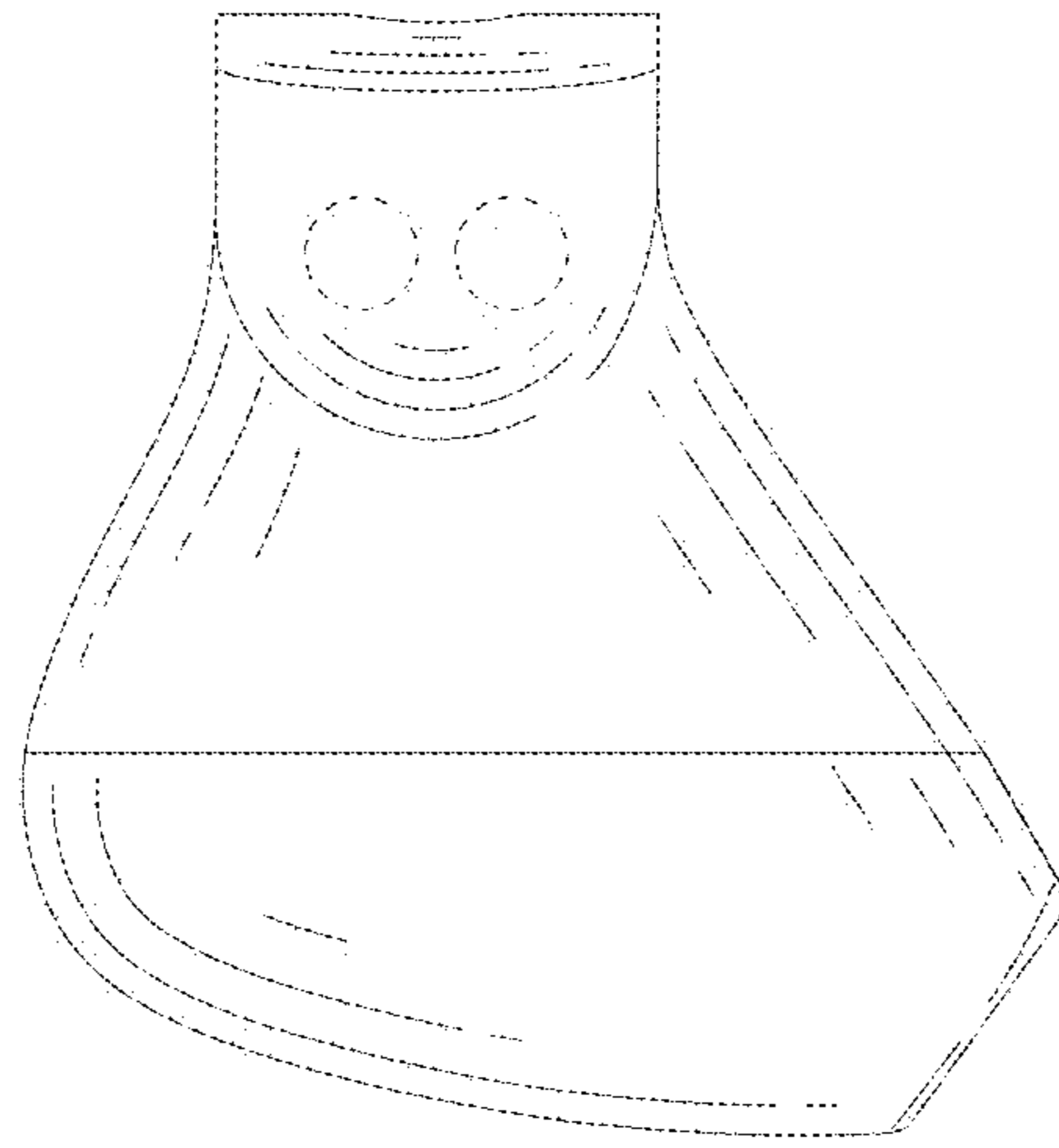


FIG. 6



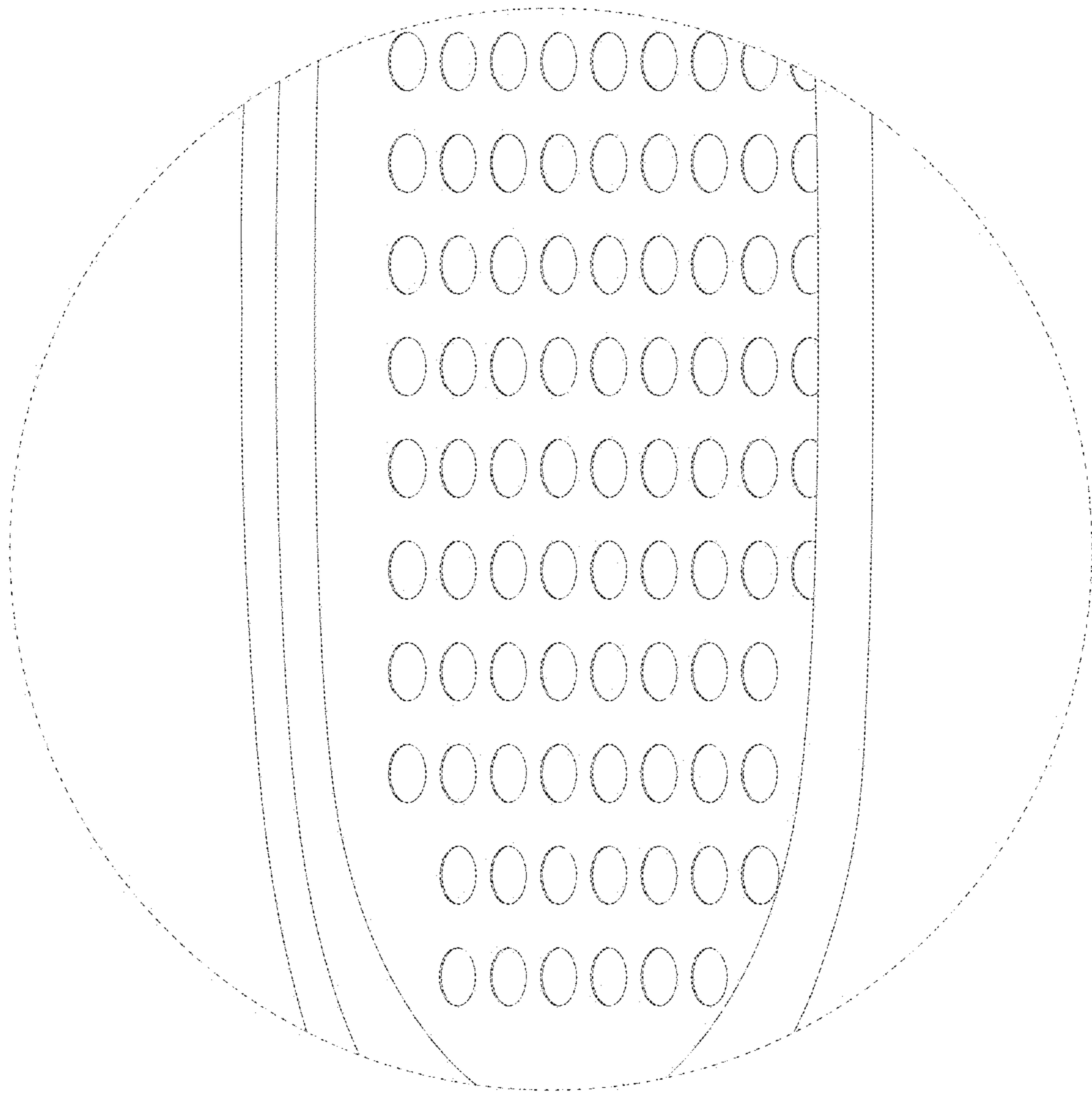


FIG. 7

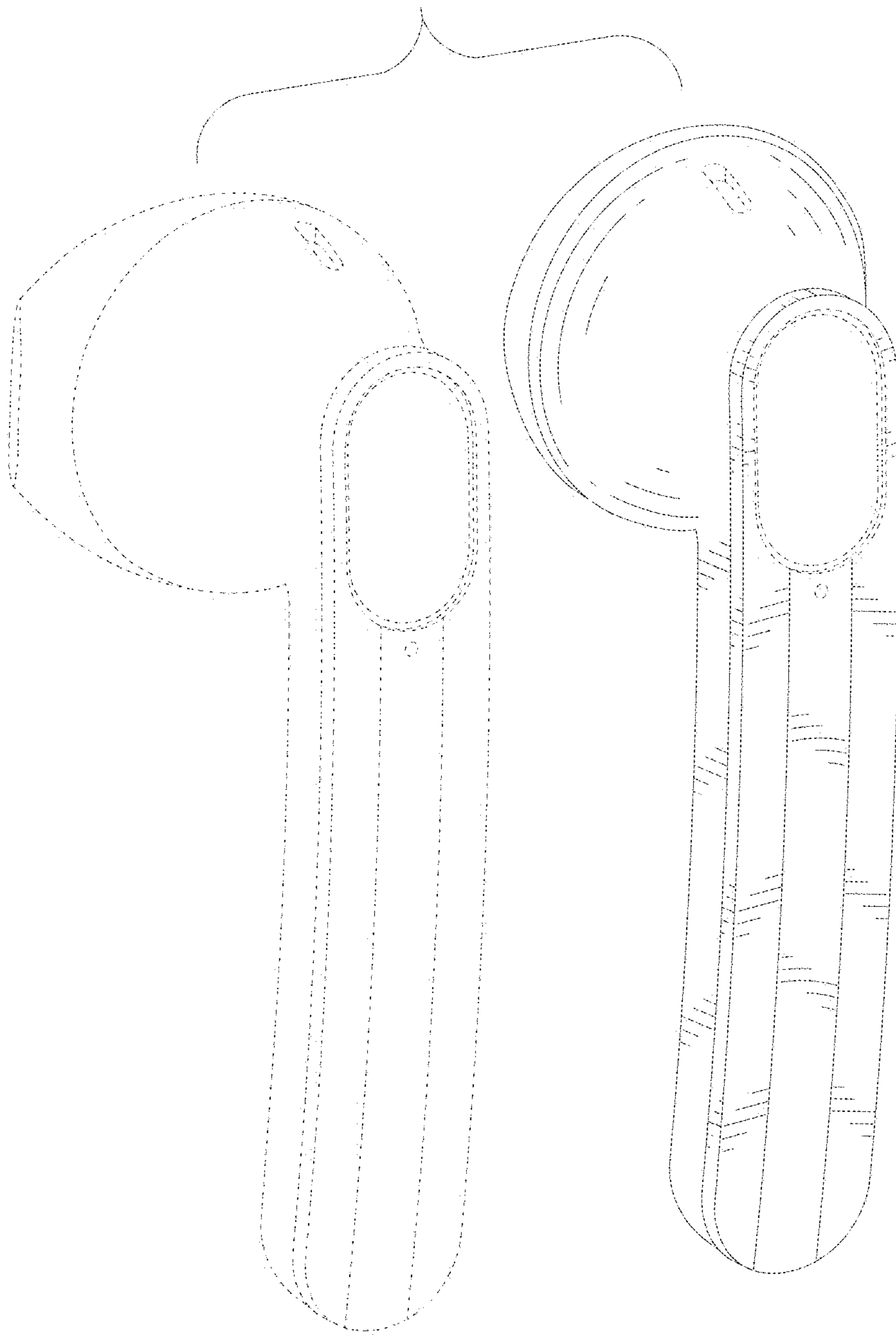


FIG. 8